

### HOSTAFORM®

Chemical abbreviation according to ISO 1043-1: POM-HI Molding compound ISO 29988- POM-K, M-GNPR, 05-001 POM copolymer, modified Easy flowing, elastomer-containing injection molding type based on HOSTAFORM® C 27021 with high toughness, and slightly lower hardness, rigidity and chemical resistance than the basic type; high resistance to thermal and oxidative degradation. UL-registration in natural and a thickness more than 1.57 mm as UL 94 HB. Burning rate ISO 3795 and FMVSS 302 < 100 mm/min for a thickness more than 1 mm thickness. Ranges of applications: For thin-walled molded parts with high energy-absorbing capacity. UL = Underwriters Laboratories (USA) FMVSS = Federal Motor Vehicle Safety Standard (USA)

#### Product information

Resin Identification Part Marking Code	POM-HI >POM-HI<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate Temperature Load	18 190 2.16		ISO 1133
Moulding shrinkage, parallel Moulding shrinkage, normal	1.8 1.7	%	ISO 294-4, 2577 ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus Tensile stress at yield, 50mm/min Tensile strain at yield, 50mm/min Nominal strain at break Flexural modulus Tensile creep modulus, 1h Tensile creep modulus, 1000h Charpy impact strength, 23°C Charpy impact strength, -30°C Charpy notched impact strength, -30°C Charpy notched impact strength, -30°C Puncture energy, 23°C Ball indentation hardness, H 358/30 Poisson's ratio [P]: Partial Break [C]: Calculated	10 35 1700 1400 800 150 <sup>[P]</sup> 110 11 6 35	MPa % MPa MPa MPa kJ/m <sup>2</sup> kJ/m <sup>2</sup> kJ/m <sup>2</sup>	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 899-1 ISO 899-1 ISO 179/1eU ISO 179/1eU ISO 179/1eA ISO 6603-2 ISO 2039-1
Thermal properties Melting temperature, 10°C/min Temperature of deflection under load, 1.8 MPa Coefficient of linear thermal expansion (CLTE), parallel		°C °C E-6/K	ISO 11357-1/-3 ISO 75-1/-2 ISO 11359-1/-2
Flammability Burning Behav. at 1.5mm nom. thickn. Thickness tested Burning Behav. at thickness h Thickness tested	1.6	class mm class mm	IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10

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### **HOSTAFORM®**

UL recognition		yes		UL 94
Electrical properties				
Relative permittivity, 100Hz Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength Comparative tracking index		1E13	E-4 Ohm.m	IEC 62631-2-1 IEC 62631-2-1 IEC 62631-2-1 IEC 62631-2-1 IEC 62631-3-1 IEC 62631-3-2 IEC 60243-1 IEC 60112
Physical/Other properties				
Humidity absorption, 2mm Water absorption, 2mm Density		0.25 0.65 1370		Sim. to ISO 62 Sim. to ISO 62 ISO 1183
Injection				
Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature Screw tangential speed Mold Temperature Optimum Min. mould temperature Max. mould temperature Hold pressure range Back pressure Ejection temperature		60 70 60 - 120	h % °C °C °C m/s °C °C MPa MPa	
Characteristics				
Processing	Injection Moulding			
Delivery form	Pellets			

Delivery form	Pellets
Additives	Release agent
Special characteristics	High impact or impact modified, High Flow

### Additional information

**Processing Notes** 

### **Pre-Drying**

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

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ADDITIONAL INFORMATION

Natural Black 12

# HOSTAFORM<sup>®</sup> S 27064

## HOSTAFORM®

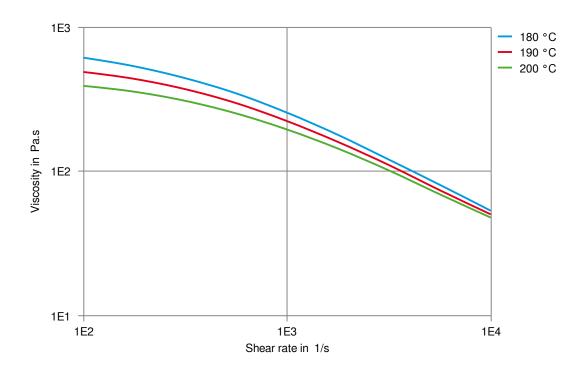
#### Storage

The product can then be stored in standard conditions until processed.

#### Automotive

OEM	STANDARD	
BMW	GS93016	
Ford	WSK-M4D618-A2	
Ford	WSK-M4D618-A2	

#### Viscosity-shear rate

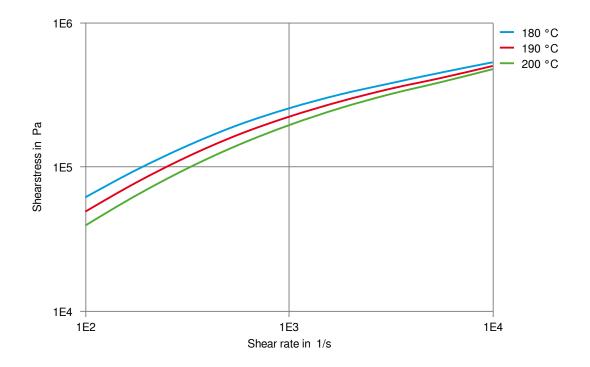






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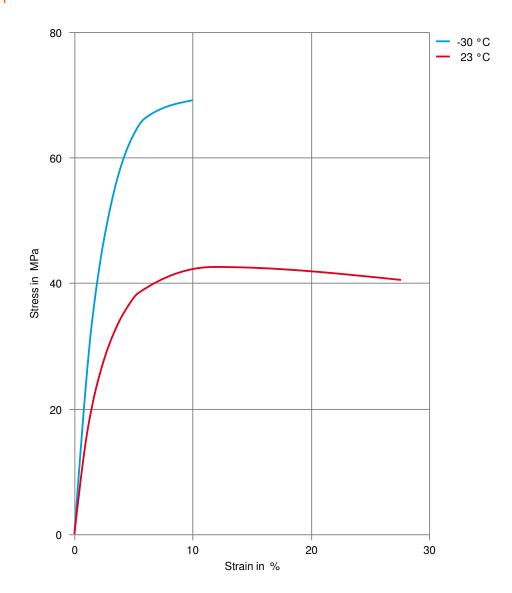
Shearstress-shear rate





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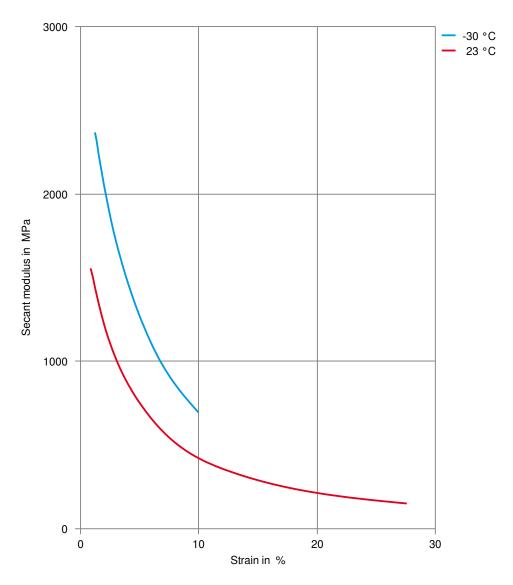
Stress-strain





### **HOSTAFORM®**

#### Secant modulus-strain



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